

BFG505; BFG505/X

NPN 9 GHz wideband transistors

Rev. 04 — 22 November 2007

Product data sheet

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NPN 9 GHz wideband transistors

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FEATURES

- High power gain
- Low noise figure
- High transition frequency
- Gold metallization ensures excellent reliability.

APPLICATIONS

RF front end applications in the GHz range, such as analog and digital cellular telephones, cordless telephones (CT1, CT2, DECT, etc.), radar detectors, pagers and satellite TV tuners (SATV).

DESCRIPTION

NPN silicon planar epitaxial transistor in a 4-pin dual-emitter SOT143B plastic package.

MARKING

| TYPE NUMBER | CODE |
|-------------|------|
| BFG505 | %ME |
| BFG505/X | %MK |

PINNING

| PIN | DESCRIPTION | |
|-----|-------------|-----------|
| | BFG505 | BFG505/X |
| 1 | collector | collector |
| 2 | base | emitter |
| 3 | emitter | base |
| 4 | emitter | emitter |

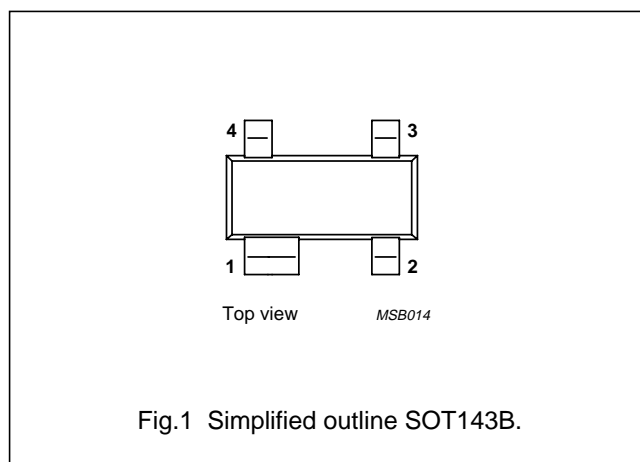


Fig.1 Simplified outline SOT143B.

QUICK REFERENCE DATA

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|--------------|-------------------------------|--|------|------|------|------|
| V_{CBO} | collector-base voltage | open emitter | – | – | 20 | V |
| V_{CES} | collector-emitter voltage | $R_{BE} = 0$ | – | – | 15 | V |
| I_C | collector current (DC) | | – | – | 18 | mA |
| P_{tot} | total power dissipation | $T_s \leq 130\text{ °C}$ | – | – | 150 | mW |
| h_{FE} | DC current gain | $V_{CE} = 6\text{ V}; I_C = 5\text{ mA}$ | 60 | 120 | 250 | |
| C_{re} | feedback capacitance | $V_{CB} = 6\text{ V}; I_C = I_c = 0; f = 1\text{ MHz}$ | – | 0.2 | – | pF |
| f_T | transition frequency | $V_{CE} = 6\text{ V}; I_C = 5\text{ mA}; f = 1\text{ GHz}$ | – | 9 | – | GHz |
| G_{UM} | maximum unilateral power gain | $V_{CE} = 6\text{ V}; I_C = 5\text{ mA}; T_{amb} = 25\text{ °C}; f = 900\text{ MHz}$ | – | 20 | – | dB |
| | | $V_{CE} = 6\text{ V}; I_C = 5\text{ mA}; T_{amb} = 25\text{ °C}; f = 2\text{ GHz}$ | – | 13 | – | dB |
| $ S_{21} ^2$ | insertion power gain | $V_{CE} = 6\text{ V}; I_C = 5\text{ mA}; T_{amb} = 25\text{ °C}; f = 900\text{ MHz}$ | 16 | 17 | – | dB |
| F | noise figure | $\Gamma_s = \Gamma_{opt}; V_{CE} = 6\text{ V}; I_C = 1.25\text{ mA}; T_{amb} = 25\text{ °C}; f = 900\text{ MHz}$ | – | 1.2 | 1.7 | dB |
| | | $\Gamma_s = \Gamma_{opt}; V_{CE} = 6\text{ V}; I_C = 5\text{ mA}; T_{amb} = 25\text{ °C}; f = 900\text{ MHz}$ | – | 1.6 | 2.1 | dB |
| | | $\Gamma_s = \Gamma_{opt}; V_{CE} = 6\text{ V}; I_C = 1.25\text{ mA}; T_{amb} = 25\text{ °C}; f = 2\text{ GHz}$ | – | 1.9 | – | dB |

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LIMITING VALUES

In accordance with the Absolute Maximum System (IEC 134).

| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | UNIT |
|------------------|---------------------------|--|------|------|------|
| V _{CBO} | collector-base voltage | open emitter | – | 20 | V |
| V _{CES} | collector-emitter voltage | R _{BE} = 0 | – | 15 | V |
| V _{EBO} | emitter-base voltage | open collector | – | 2.5 | V |
| I _C | collector current (DC) | | – | 18 | mA |
| P _{tot} | total power dissipation | T _s ≤ 130 °C; see Fig.2; note 1 | – | 150 | mW |
| T _{stg} | storage temperature range | | –65 | 150 | °C |
| T _j | junction temperature | | – | 175 | °C |

Note

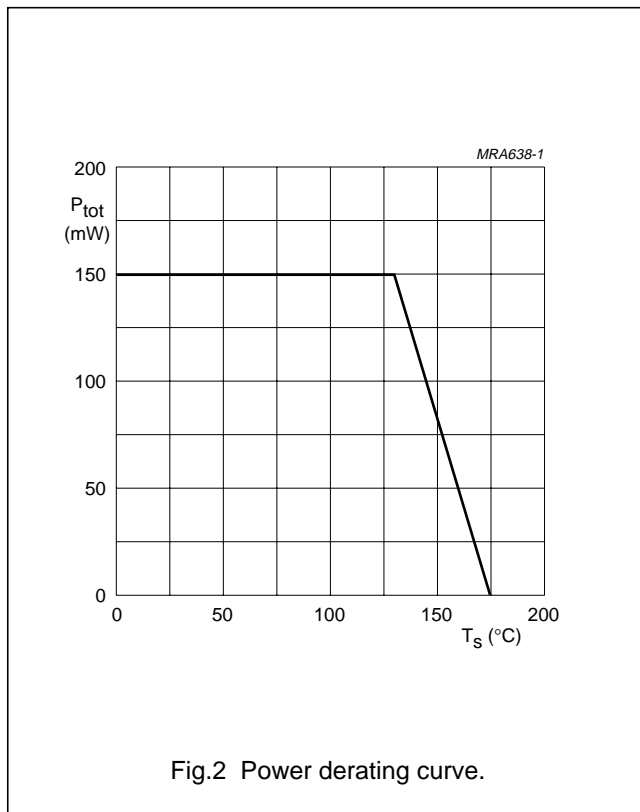
1. T_s is the temperature at the soldering point of the collector pin.

THERMAL CHARACTERISTICS

| SYMBOL | PARAMETER | CONDITIONS | VALUE | UNIT |
|---------------------|---|------------|-------|------|
| R _{th j-s} | thermal resistance from junction to soldering point | note 1 | 290 | K/W |

Note

1. T_s is the temperature at the soldering point of the collector pin.



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CHARACTERISTICS

$T_j = 25\text{ °C}$ unless otherwise specified.

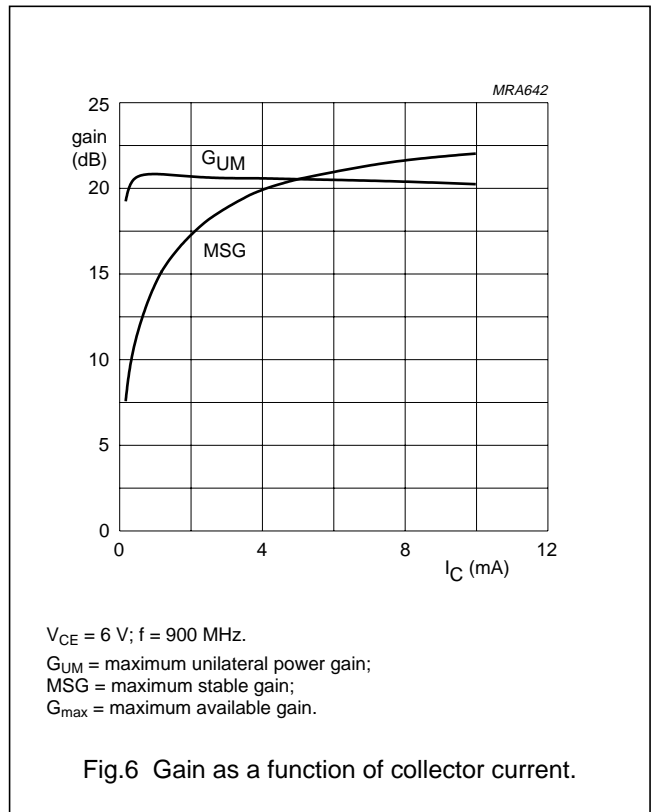
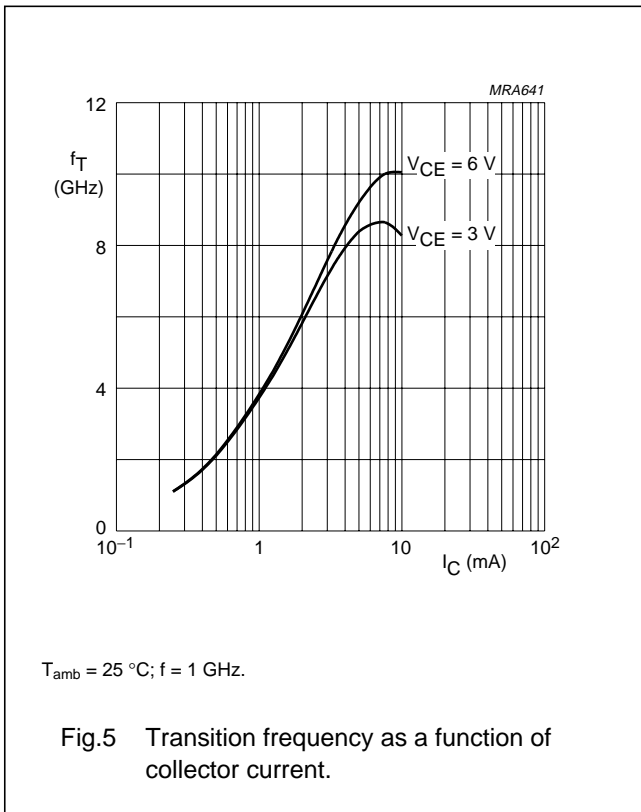
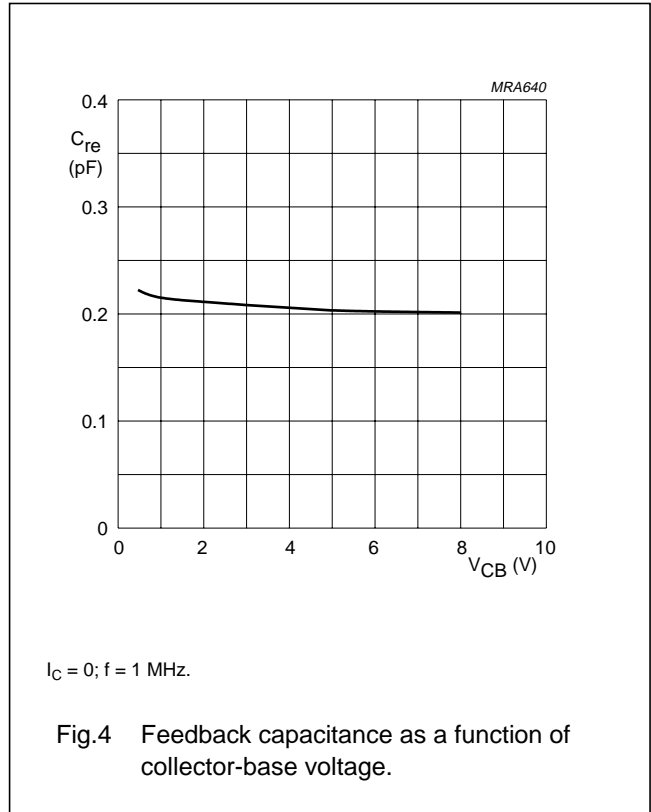
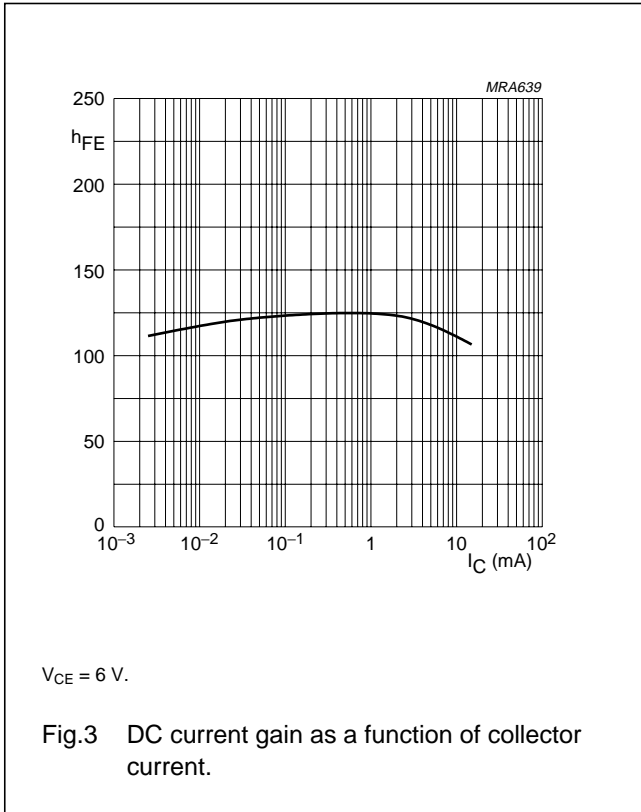
| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|--------------|---------------------------------------|---|------|------|------|------|
| I_{CBO} | collector cut-off current | $V_{CB} = 6\text{ V}; I_E = 0$ | – | – | 50 | nA |
| h_{FE} | DC current gain | $I_C = 5\text{ mA}; V_{CE} = 6\text{ V};$ see Fig.3 | 60 | 120 | 250 | |
| C_e | emitter capacitance | $I_C = I_C = 0\text{ V}; V_{EB} = 0.5\text{ V}; f = 1\text{ MHz}$ | – | 0.4 | – | pF |
| C_c | collector capacitance | $V_{CB} = 6\text{ V}; I_E = I_E = 0; f = 1\text{ MHz}$ | – | 0.3 | – | pF |
| C_{re} | feedback capacitance | $I_C = 0; V_{CB} = 6\text{ V}; f = 1\text{ MHz};$ see Fig.4 | – | 0.2 | – | pF |
| f_T | transition frequency | $I_C = 5\text{ mA}; V_{CE} = 6\text{ V}; f = 1\text{ GHz};$ see Fig.5 | – | 9 | – | GHz |
| G_{UM} | maximum unilateral power gain; note 1 | $I_C = 5\text{ mA}; V_{CE} = 6\text{ V};$ $T_{amb} = 25\text{ °C}; f = 900\text{ MHz}$ | – | 20 | – | dB |
| | | $I_C = 5\text{ mA}; V_{CE} = 6\text{ V};$ $T_{amb} = 25\text{ °C}; f = 2\text{ GHz}$ | – | 13 | – | dB |
| $ S_{21} ^2$ | insertion power gain | $I_C = 5\text{ mA}; V_{CE} = 6\text{ V};$ $T_{amb} = 25\text{ °C}; f = 900\text{ MHz}$ | 16 | 17 | – | dB |
| F | noise figure | $\Gamma_s = \Gamma_{opt}; I_C = 1.25\text{ mA}; V_{CE} = 6\text{ V};$ $T_{amb} = 25\text{ °C}; f = 900\text{ MHz}$ | – | 1.2 | 1.7 | dB |
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| | | $\Gamma_s = \Gamma_{opt}; I_C = 1.25\text{ mA}; V_{CE} = 6\text{ V};$ $T_{amb} = 25\text{ °C}; f = 2\text{ GHz}$ | – | 1.9 | – | dB |
| P_{L1} | output power at 1 dB gain compression | $I_C = 5\text{ mA}; V_{CE} = 6\text{ V}; R_L = 50\text{ }\Omega;$ $T_{amb} = 25\text{ °C}; f = 900\text{ MHz}$ | – | 4 | – | dBm |
| ITO | third order intercept point | note 2 | – | 10 | – | dBm |

Notes

- G_{UM} is the maximum unilateral power gain, assuming S_{12} is zero and $G_{UM} = 10 \log \frac{|S_{21}|^2}{(1 - |S_{11}|^2)(1 - |S_{22}|^2)}$ dB.
- $V_{CE} = 6\text{ V}; I_C = 5\text{ mA}; R_L = 50\text{ }\Omega; T_{amb} = 25\text{ °C};$
 $f_p = 900\text{ MHz}; f_q = 902\text{ MHz};$
measured at $2f_p - f_q = 898\text{ MHz}$ and $2f_q - f_p = 904\text{ MHz}.$

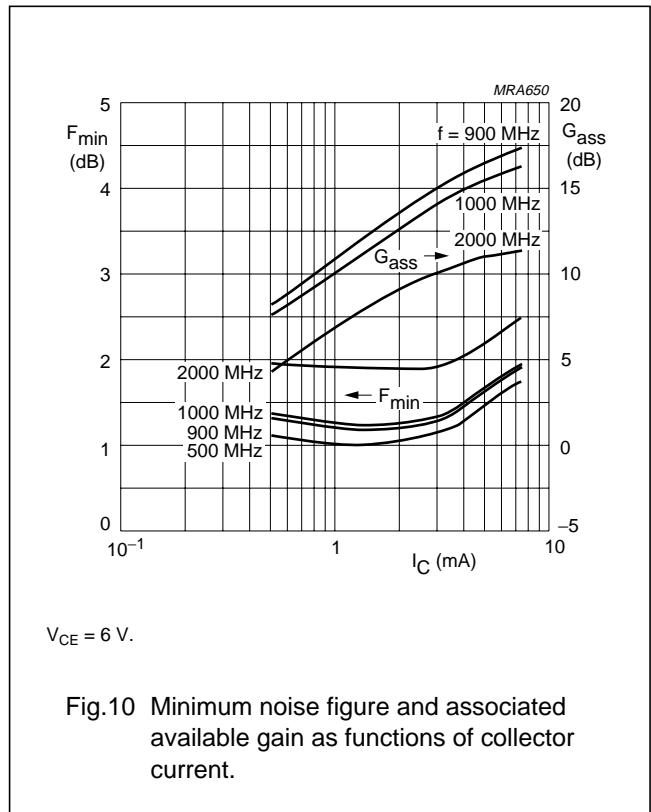
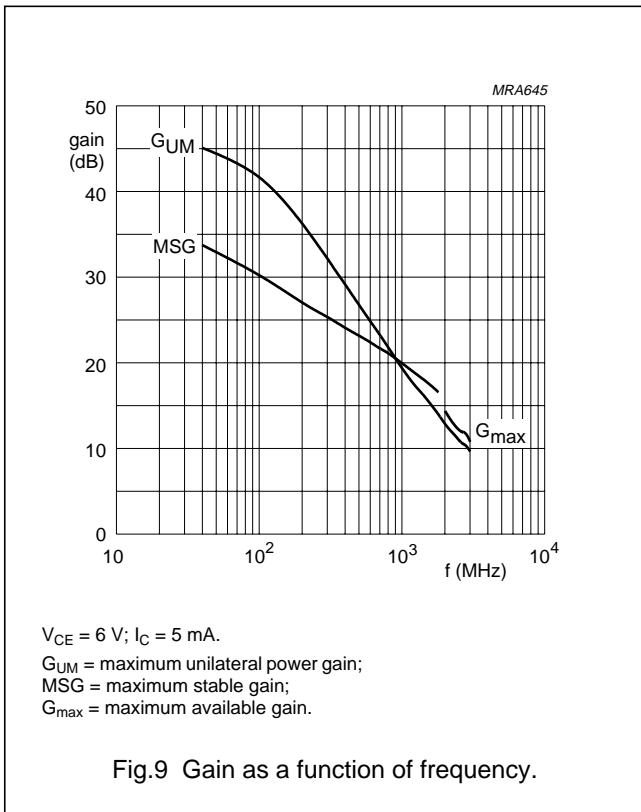
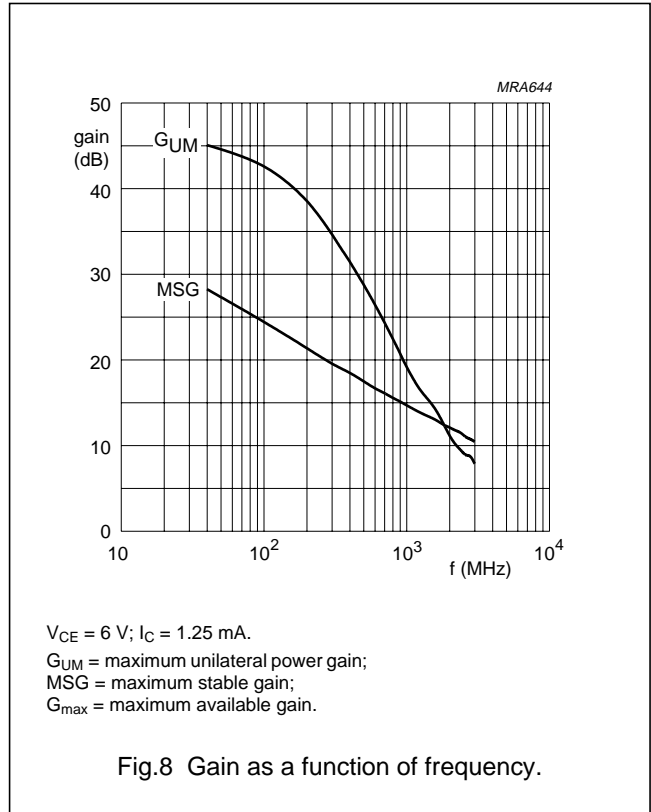
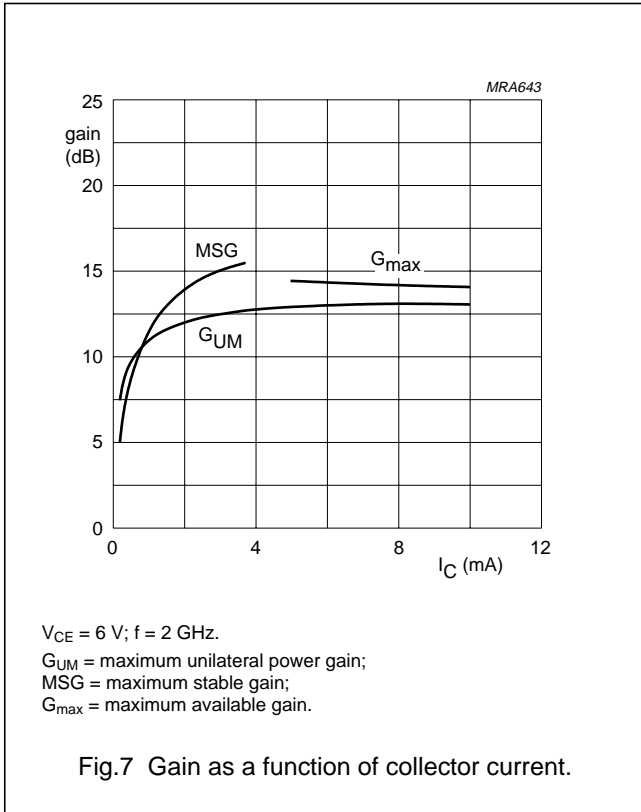
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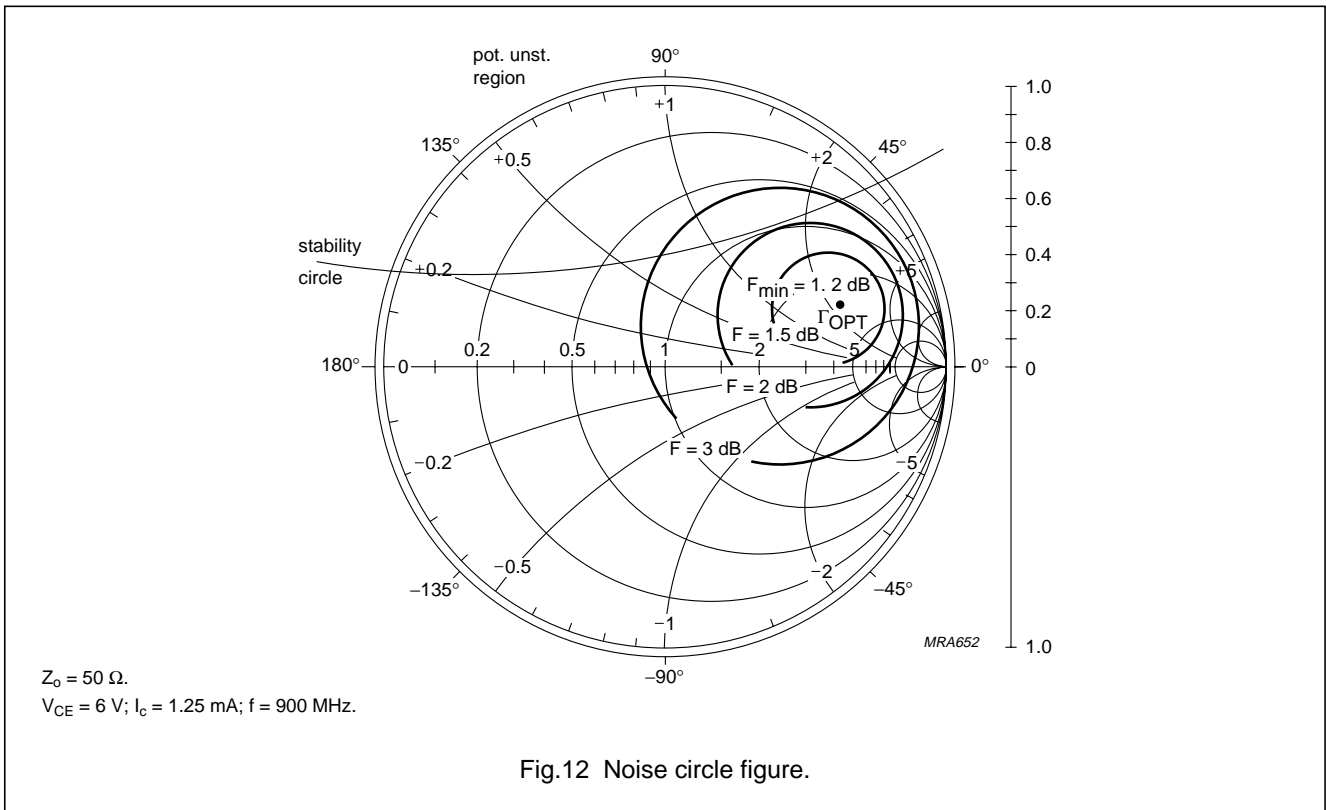
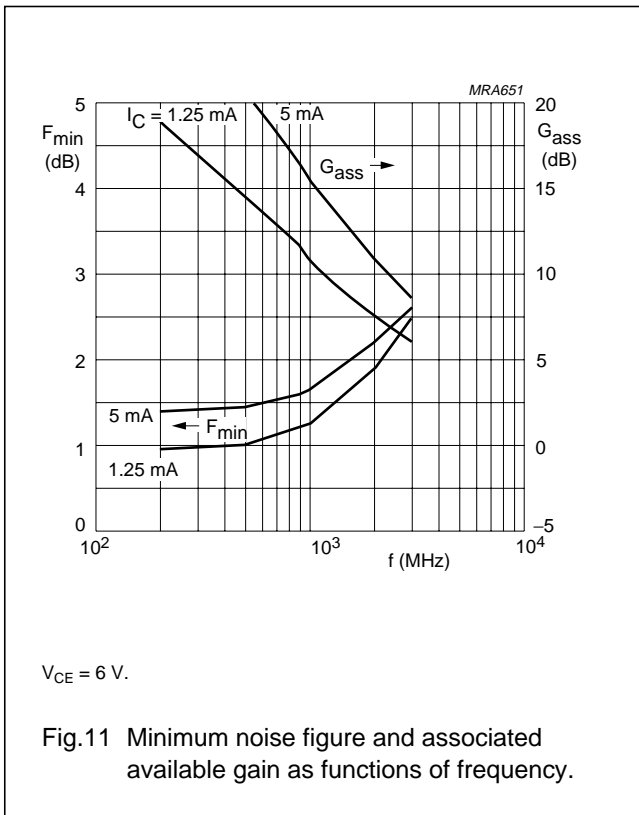
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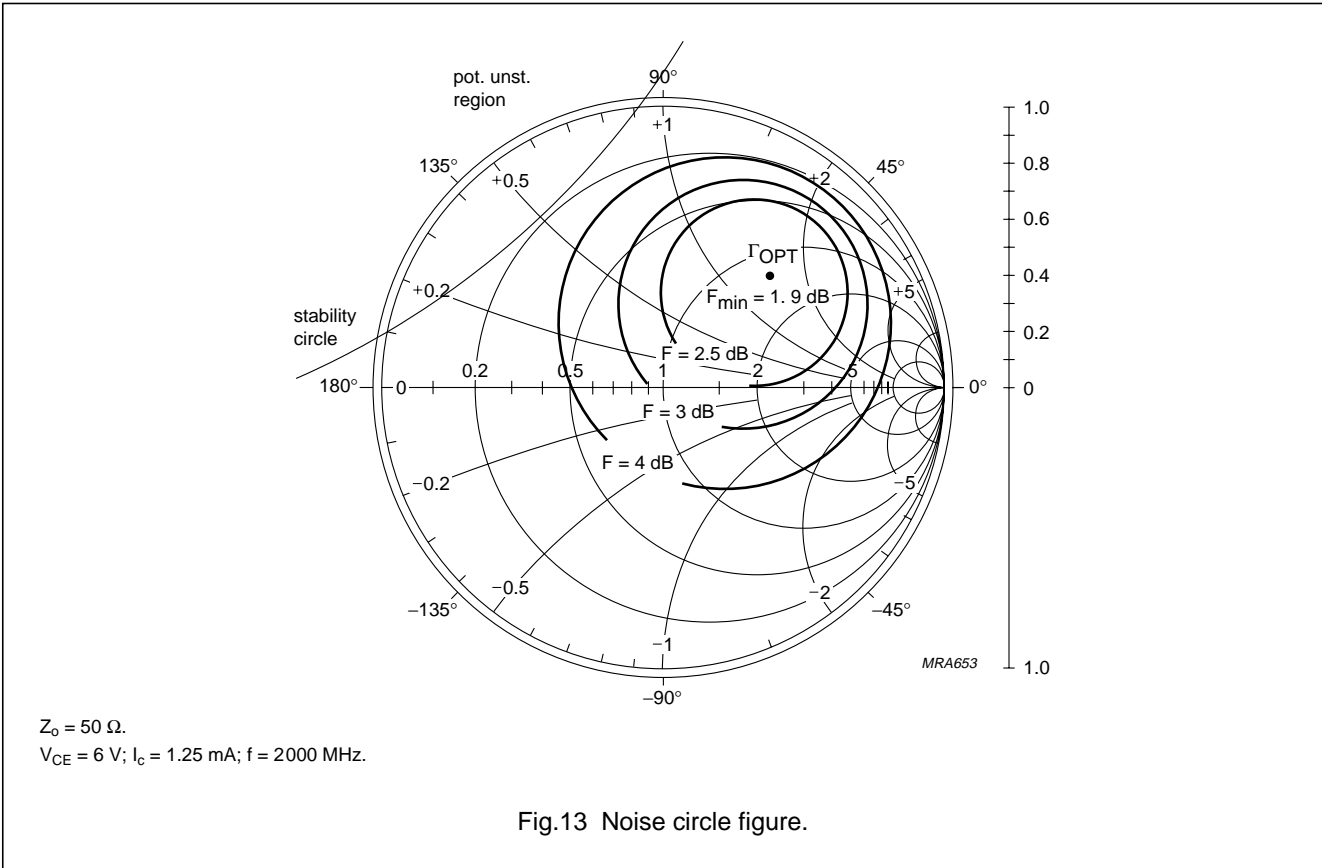
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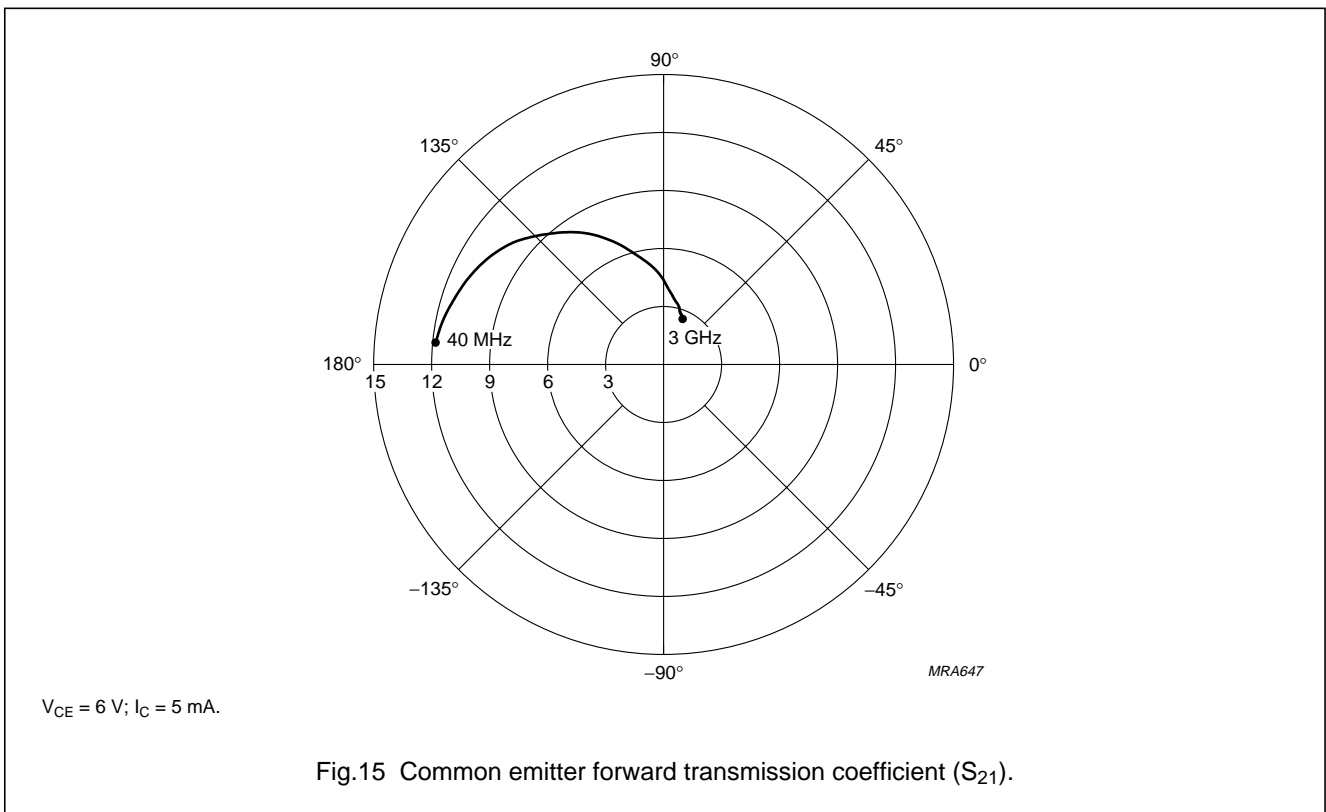
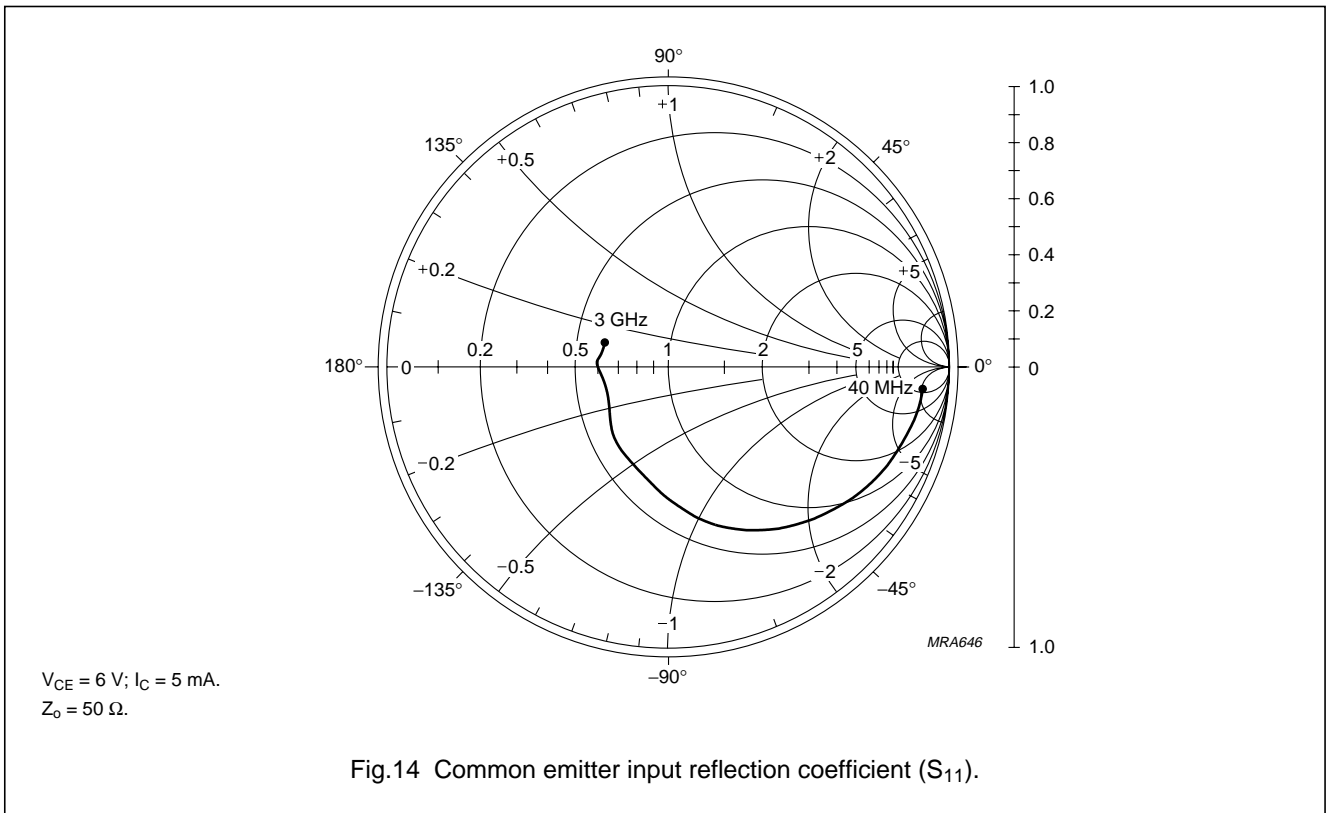
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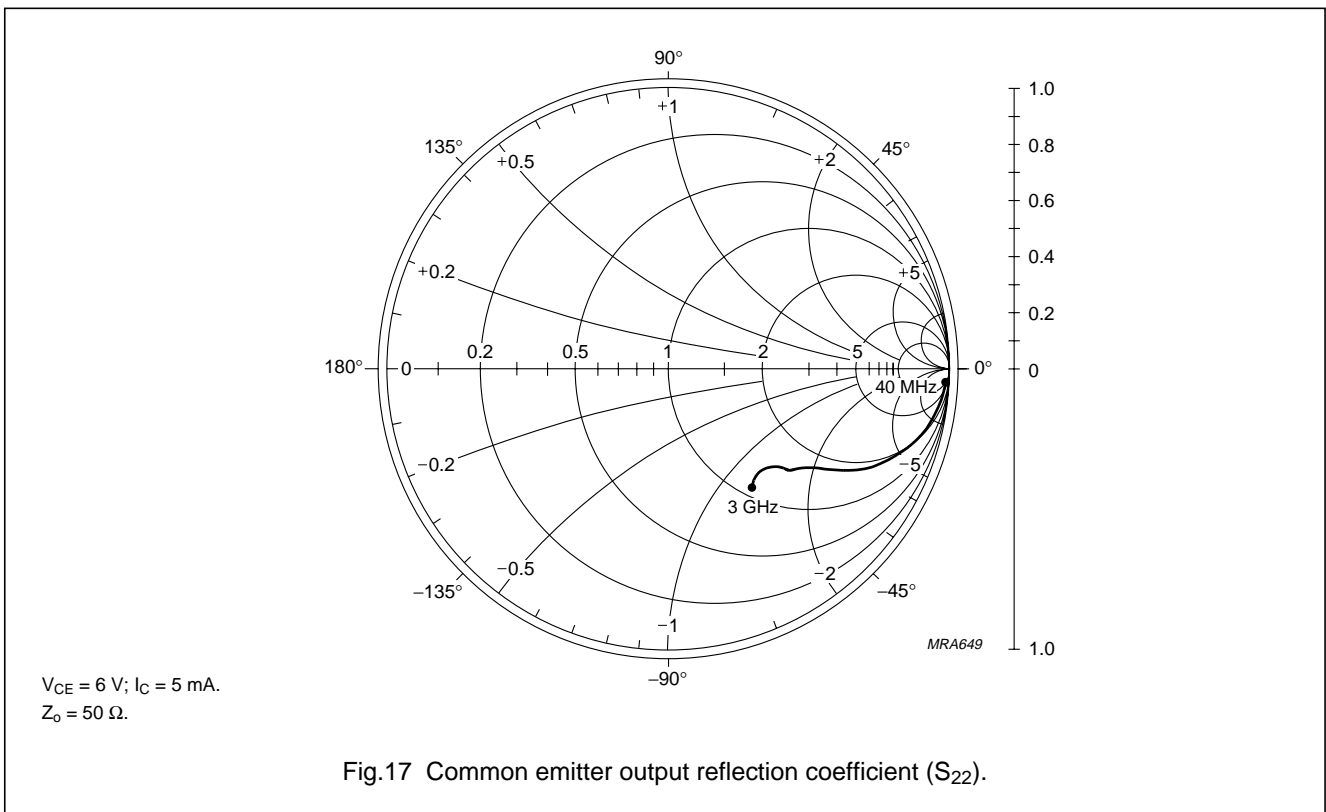
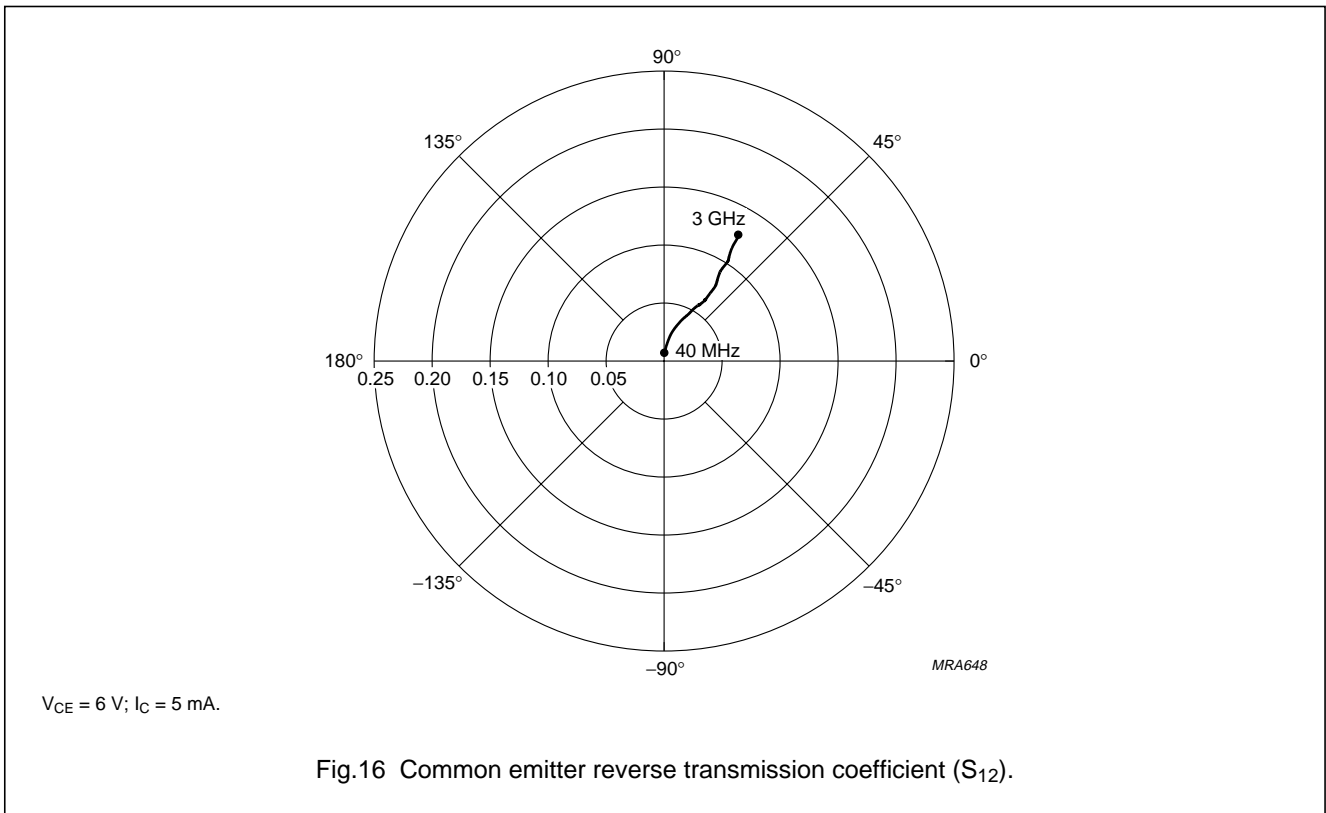
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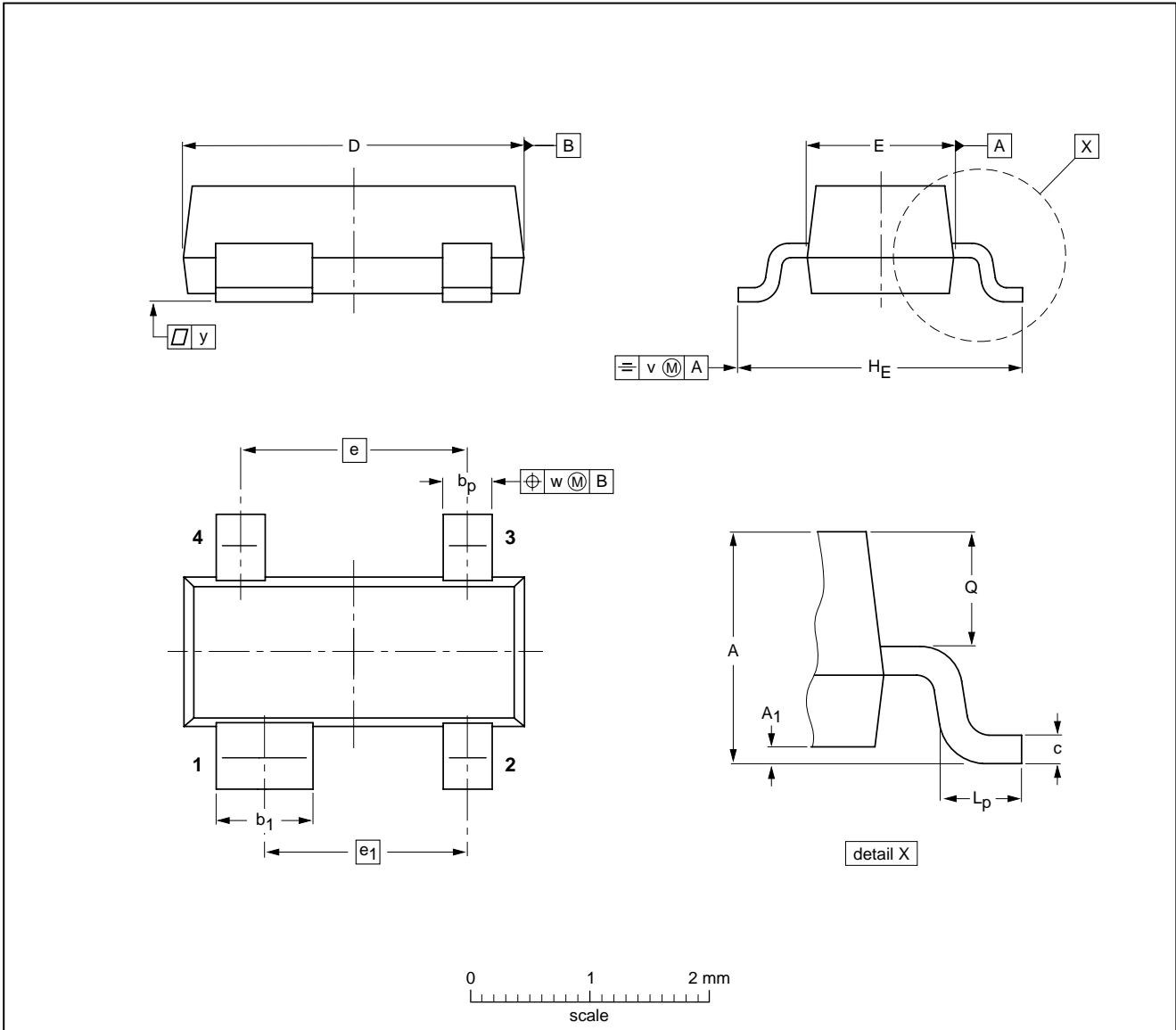
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PACKAGE OUTLINE

Plastic surface mounted package; 4 leads

SOT143B



DIMENSIONS (mm are the original dimensions)

| UNIT | A | A ₁ max | b _p | b ₁ | c | D | E | e | e ₁ | H _E | L _p | Q | v | w | y |
|------|------------|-----------------------|----------------|----------------|--------------|------------|------------|-----|----------------|----------------|----------------|--------------|-----|-----|-----|
| mm | 1.1 0.9 | 0.1 | 0.48 0.38 | 0.88 0.78 | 0.15 0.09 | 3.0 2.8 | 1.4 1.2 | 1.9 | 1.7 | 2.5 2.1 | 0.45 0.15 | 0.55 0.45 | 0.2 | 0.1 | 0.1 |

| OUTLINE VERSION | REFERENCES | | | | EUROPEAN PROJECTION | ISSUE DATE |
|--------------------|------------|-------|------|--|------------------------|------------|
| | IEC | JEDEC | EIAJ | | | |
| SOT143B | | | | | | 97-02-28 |

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|-----------------------------------|-------------------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
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[2] The term 'short data sheet' is explained in section "Definitions".

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| Document ID | Release date | Data sheet status | Change notice | Supersedes |
|--------------------------------|---|-----------------------|---------------|----------------|
| BFG505_X_N_4 | 20071122 | Product data sheet | - | BFG505_X_3 |
| Modifications: | • Marking table on page 2; changed code | | | |
| BFG505_X_3 (9397 750 04348) | 19981002 | Product specification | - | BFG505XR_CNV_2 |
| BFG505XR_CNV_2 | 19950901 | Product specification | - | BFG505XR_1 |
| BFG505XR_1 | 19921101 | Product specification | - | - |

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